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1. Name of conveying party(ies):
Tsuguhiro KORENAGA, Nobuki ITOH, Masaaki TOJO and Toshihiko WADA
Additional name(s) of conveying party(ies) attached? NO

2. Name and address of receiving party(ies):
Name: Matsushita Electric Industrial Co., Ltd.
Street Address: 1006, Oazakadoma, Kadoma-shi, Osaka-fu 571-8501 Japan

3. Nature of conveyance: MRD 12/3/02
 Assignment Merger
 Security Agreement Change of Name
 Other _____
Execution Date: November 27, 2002

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JC903 U.S. PTO
10/308007
12/03/02

4. Application number(s) or patent number(s):
If this document is being filed together with a new application, the execution date of the application is: November 27, 2002
A. Patent Application No.(s) 10308007 B. Patent No.(s)
Additional numbers attached? NO

5. Name and address of party to whom correspondence concerning document should be mailed:
Name: WENDEROTH, LIND & PONACK, L.L.P.
Attn: Charles R. Watts, Esq.
Street Address: 2033 K Street, N.W., Suite 800
City: Washington, State: DC ZIP: 20006-1021

6. Total number of applications and patents involved: 1
7. Total fee (37 CFR 3.41). \$40.00
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Authorized to be charged to deposit account
8. Deposit account number: 23-0975
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9. Statement and signature.
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.
Charles R. Watts, Reg. No. 33,142 December 3, 2002
Name of Person Signing Signature Date
Total number of pages including cover sheet: 3

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ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Insert Name(s)
of Inventor(s)

Tsuguhiro KORENAGA, Nobuki ITOH, Masaaki TOJO
and Toshihiko WADA

the undersigned hereby sell(s) and assign(s) to

Insert Name(s)
of Assignee(s)
Address

Matsushita Electric Industrial Co., Ltd.
of 1006, Oazakadoma, Kadoma-shi, Osaka-fu 571-8501 Japan

(hereinafter designated as the Assignee) the entire right, title and interest for the United States as defined in 35 USC 100, in the invention known as

Title of
Invention

OPTICAL PACKAGE SUBSTRATE, OPTICAL DEVICE, OPTICAL MODULE,
AND METHOD FOR MOLDING OPTICAL PACKAGE SUBSTRATE

for which an application for patent in the United States has been executed by the undersigned

Date of
Signing
of Application

on November 27, 2002

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 2033 K Street, N.W., Suite 800, Washington, D.C. 20006-1021, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date November 27, 2002, Name of the Inventor Tsuguhiko Korenaga
 Date November 27, 2002, Name of the Inventor Nobuki Itoh Tsuguhiko KORENAGA
 Date November 27, 2002, Name of the Inventor Masaaki Tojo Nobuki ITOH
 Date November 27, 2002, Name of the Inventor Toshihiko Wada Masaaki TOJO
 Date _____, Name of the Inventor _____
 Date _____, Name of the Inventor _____
 Date _____, Name of the Inventor _____

(This assignment should preferably be acknowledged before a United States Consul. If not, then the execution by the Inventor(s) should be witnessed by at least two witnesses who sign here.)

Witness Hisashi Minemoto
 Witness Toshiaki Katoh

ACKNOWLEDGMENT

 _____ } ss

This _____ day of _____, 19____, before me personally came the above-named me personally known as the individual(s) who executed the foregoing assignment, who did acknowledge to me that he (they) executed the same of his (their) own free will for the purposes therein set forth.

SEAL _____

 Official Signature

 Official Title

The above application may be more particularly identified as follows:

U.S. Application Serial No. _____ Filing Date _____
 Applicant Reference Number FP-1105 Atty Docket No. _____
 Title of Invention OPTICAL PACKAGE SUBSTRATE, OPTICAL DEVICE, OPTICAL MODULE,
 AND METHOD FOR MOLDING OPTICAL PACKAGE SUBSTRATE